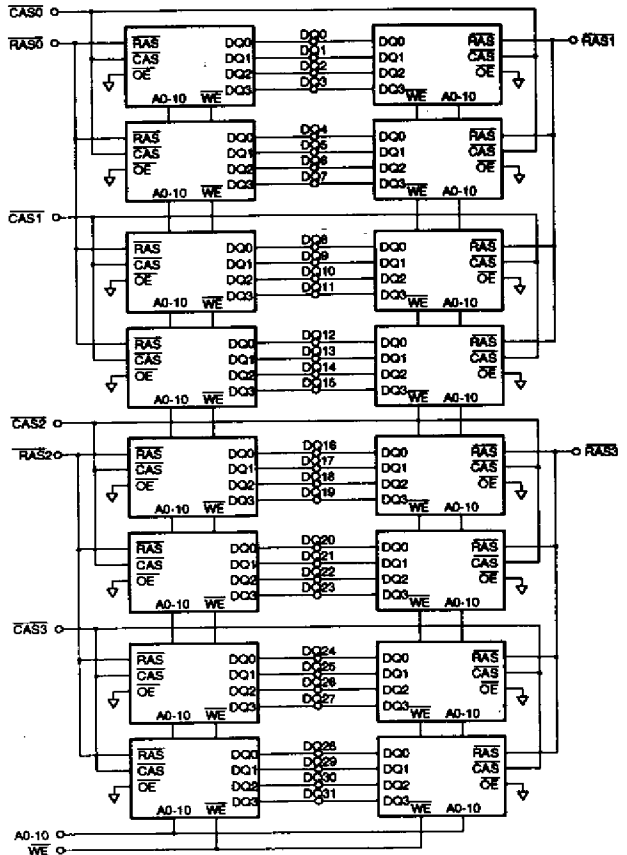


PIN NAME

BLOCK DIAGRAM

#	NAME	#	NAME
1	Vss	37	NC
2	DQ0	38	NC
3	DQ16	39	Vss
4	DQ1	40	CAS0
5	DQ17	41	CAS2
6	DQ2	42	CAS3
7	DQ18	43	CAS1
8	DQ3	44	RAS0
9	DQ19	45	RAS1
10	Vcc	46	NC
11	NC	47	WE
12	A0	48	NC
13	A1	49	DQ8
14	A2	50	DQ24
15	A3	51	DQ9
16	A4	52	DQ25
17	A5	53	DQ10
18	A6	54	DQ26
19	A10	55	DQ11
20	DQ4	56	DQ27
21	DQ20	57	DQ12
22	DQ5	58	DQ28
23	DQ21	59	Vcc
24	DQ6	60	DQ29
25	DQ22	61	DQ13
26	DQ7	62	DQ30
27	DQ23	63	DQ14
28	A7	64	DQ31
29	NC	65	DQ15
30	Vcc	66	NC
31	A8	67	PD1
32	A9	68	PD2
33	RAS3	69	PD3
34	RAS2	70	PD4
35	NC	71	NC
36	NC	72	Vss



PRESENCE DETECT PIN

PIN	-60	-70	-80
PD1	NC	NC	NC
PD2	Vss	Vss	Vss
PD3	NC	Vss	NC
PD4	NC	NC	Vss

ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER	RATING	UNIT
TA	Ambient Temperature	0 to 70	°C
TSTG	Storage Temperature	-55 to 125	°C
VIN, VOUT	Voltage on Any Pin Relative to Vss	-1.0 to 7.0	V
Vcc	Voltage on Vcc Relative to Vss	-1.0 to 7.0	V
Ics	Short Circuit Output Current	50	mA
Pd	Power Dissipation	8	W

NOTE : Operation at or above Absolute Maximum Ratings can adversely affect device reliability.

RECOMMENDED DC OPERATING CONDITIONS

(TA= 0°C to 70°C)

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT
Vcc	Supply Voltage	4.5	5.0	5.5	V
VIH	Input High Voltage	2.4	-	Vcc+ 1.0	V
VIL	Input Low Voltage	-1.0	-	0.8	V

NOTE : All voltages are referenced to Vss.

DC CHARACTERISTICS

(TA= 0°C to 70°C, VCC= 5V± 10%, VSS= 0V, unless otherwise noted.)

SYMBOL	PARAMETER	TEST CONDITIONS	SPEED/ POWER	MIN.	MAX.	UNIT	NOTE
I _I	Input Leakage Current (Any Input Pin)	V _{SS} ≤ V _{IN} ≤ V _{CC} + 1.0, All other pins not under test= V _{SS}		-160	160	μA	
I _{LO}	Output Leakage Current (High Impedance State)	V _{SS} ≤ V _{OUT} ≤ V _{CC} , RAS & CAS at V _{IH}		-20	20	μA	
I _{CC1}	V _{CC} Supply Current, Operating	trC= trC (min.)	80 70 80	- - -	976 816 736	mA	1,2,3
I _{CC2}	V _{CC} Supply Current, TTL Standby	RAS & CAS at V _{IH} , other inputs ≥ V _{SS}		-	32	mA	
I _{CC3}	V _{CC} Supply Current, RAS-only refresh	trC= trC (min.)	60 70 80	- - -	976 816 736	mA	1,3
I _{CC4}	V _{CC} Supply Current, EDO mode	thPC= thPC (min.)	60 70 80	- - -	816 736 656	mA	1,2,3
I _{CC5}	V _{CC} Supply Current, CMOS Standby	RAS & CAS ≥ V _{CC} -0.2V	SL-part	- -	16 6.4	mA	5
I _{CC6}	V _{CC} Supply Current, CAS-before-RAS refresh	trC= trC (min.)	60 70 80	- - -	976 816 736	mA	1,3
I _{CC7}	V _{CC} Supply Current, Battery Back Up (SL-part only)	trC= 125μs, CAS= CBR cycling or 0.2V WE= V _{CC} -0.2V A0-A10= V _{CC} -0.2V or 0.2V DQ0-DQ31= V _{CC} -0.2V, 0.2V, or open	trAS ≤ 300ns trAS ≤ 1μs	- - -	6.4 9.6	mA	1,4,5
I _{CC8}	V _{CC} Supply Current Self Refresh (SL-part only)	RAS & CAS ≤ 0.2V OE & WE & A0-A10= V _{CC} -0.2V or 0.2V DQ0-DQ31= V _{CC} -0.2V, 0.2V or open			4.8	mA	5
V _{OL}	Output Low Voltage	I _{OL} = 4.2mA		-	0.4	V	
V _{OH}	Output High Voltage	I _{OH} = -5mA		2.4	-	V	

NOTE :

- I_{CC1}, I_{CC3}, I_{CC4}, I_{CC6} and I_{CC7} depend on cycle rate.
- I_{CC1}, I_{CC3}, I_{CC4} and I_{CC6} depend on output loading. Specified values are obtained with the output open.
- I_{CC} is specified as average current. For I_{CC1}, I_{CC3} and I_{CC6} address can be changed maximum two times while RAS= V_{IH}. For I_{CC4}, address can be changed maximum once while CAS= V_{IH}.
- Only trAS(max.)= 1μs is applied to refresh of battery backup but trAS(max.)= 10μs is applied to normal functional operation.
- I_{CC5}(max.)= 6.4mA, I_{CC7} and I_{CC8} are applied to SL-part only (HYM532814ASLM/ASLTM/ASLMG/ASLTMG).

AC CHARACTERISTICS

(TA= 0°C to 70°C, Vcc= 5V± 10%, Vss = 0V, unless otherwise noted.) NOTE : 1, 2, 3

#	SYMBOL	PARAMETER	HYM532814A M-series						UNIT	NOTE
			-60		-70		-80			
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
1	tRC	Random Read or Write Cycle Time	110	-	130	-	150	-	ns	
2	tRPC	RAS to CAS Precharge Time	0	-	0	-	0	-	ns	
3	tHPC	EDO Mode Cycle Time	25	-	30	-	35	-	ns	
4	tRHCP	Time from CAS Precharge	35	-	40	-	45	-	ns	
5	tRAC	Access Time from RAS	-	60	-	70	-	80	ns	4,9,10
6	tCAC	Access Time from CAS	-	15	-	18	-	20	ns	4,9
7	tAA	Access Time from Column Address	-	30	-	35	-	40	ns	4,10
8	tCPA	Access Time from CAS Precharge	-	35	-	40	-	45	ns	4
9	tCLZ	CAS to Output Low Impedance	0	-	0	-	0	-	ns	4
10	tCEZ	Output Buffer Turn-off Delay	0	15	0	15	0	15	ns	5
11	tT	Transition Time (Rise and Fall)	2	50	2	50	2	50	ns	3
12	tRP	RAS Precharge Time	40	-	50	-	60	-	ns	
13	tRAS	RAS Pulse Width	60	10K	70	10K	80	10K	ns	
14	tRASP	RAS Pulse Width (EDO Mode)	60	125K	70	125K	80	125K	ns	
15	tRSH	RAS Hold Time	15	-	18	-	20	-	ns	
16	tCSH	CAS Hold Time	40	-	50	-	60	-	ns	
17	tCAS	CAS Pulse Width	12	10K	15	10K	20	10K	ns	
18	tRCD	RAS to CAS Delay	20	45	20	50	20	60	ns	9
19	tRAD	RAS to Column Address Delay Time	15	30	15	30	17	40	ns	10
20	tCRP	CAS to RAS Precharge Time	5	-	5	-	5	-	ns	
21	tCP	CAS Precharge Time	8	-	10	-	10	-	ns	
22	tASR	Row Address Set-up Time	0	-	0	-	0	-	ns	
23	tRAH	Row Address Hold Time	10	-	10	-	12	-	ns	
24	tASC	Column Address Set-up Time	0	-	0	-	0	-	ns	
25	tCAH	Column Address Hold Time	10	-	10	-	15	-	ns	
26	tAR	Column Address Hold Time from RAS	50	-	55	-	60	-	ns	
27	tRAL	Column Address to RAS Lead Time	30	-	35	-	40	-	ns	
28	tRCS	Read Command Set-up Time	0	-	0	-	0	-	ns	
29	tRCH	Read Command Hold Time Referenced to CAS	0	-	0	-	0	-	ns	6
30	tRRH	Read Command Hold Time Referenced to RAS	0	-	0	-	0	-	ns	6
31	tWCH	Write Command Hold Time	10	-	10	-	15	-	ns	
32	tWCR	Write Command Hold Time from RAS	45	-	50	-	55	-	ns	
33	tWP	Write Command Pulse Width	10	-	10	-	15	-	ns	
34	tRWL	Write Command to RAS Lead Time	15	-	18	-	20	-	ns	
35	tCWL	Write Command to CAS Lead Time	15	-	18	-	20	-	ns	
36	tDS	Data-In Set-up Time	0	-	0	-	0	-	ns	7
37	tDH	Data-In Hold Time	13	-	13	-	15	-	ns	7
38	tDHR	Data-In Hold Time Referenced to RAS	50	-	55	-	60	-	ns	
39	tREF	Refresh Period (2048 cycles)	-	32	-	32	-	32	ms	
		SL-part	-	256	-	256	-	256	ms	12
40	tWCS	Write Command Set-up Time	0	-	0	-	0	-	ns	8

AC CHARACTERISTICS

(continued)

#	SYMBOL	PARAMETER	HYM532814A M-Series						UNIT	NOTE
			-60		-70		-80			
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
41	tCSR	CAS Set-up Time (CBR Cycle)	5	-	5	-	5	-	ns	
42	tCHR	CAS Hold Time (CBR Cycle)	10	-	10	-	10	-	ns	
43	tCPT	CAS Precharge Time (CBR Counter Test)	20	-	25	-	25	-	ns	
44	tWRP	WE to RAS Precharge Time (CBR Cycle)	10	-	10	-	10	-	ns	
45	tWRH	WE to RAS Hold Time (CBR Cycle)	10	-	10	-	10	-	ns	
46	tRASS	RAS Pulse (Self Refresh)	100	-	100	-	100	-	ns	
47	tRPS	RAS Precharge Time (Self Refresh)	110	-	130	-	150	-	ns	
48	tCHS	CAS Hold Time from RAS (Self Refresh)	-50	-	-50	-	-50	-	ns	
49	tDOH	Output Data Hold Time	3	-	3	-	3	-	ns	
50	tREZ	Output Buffer Turn-off Delay (RAS)	-	15	-	15	-	15	ns	5,15
51	tWEZ	Output Buffer Turn-off Delay (WE)	-	15	-	15	-	15	ns	5
52	tWPE	WE Pulse Width for Output Disable	10	-	10	-	10	-	ns	
53	tWED	WE to Data Delay Time	15	-	15	-	15	-	ns	

NOTE :

1. An initial pause of 200 μ s is required after power-up followed by 8 RAS cycles before proper device operation is achieved. In case of using internal refresh counter, a minimum of 8 CAS-before-RAS initialization cycles instead of 8 RAS-only refresh cycles are required. The device should be carefully initialized to be prevented from being entered into multi bit test mode.
2. If RAS= Vss during power-up the HYM532814A could begin an active cycle. This condition results in higher power-up current than necessary demands from the power-up. It is recommended that RAS and CAS track with VCC during power-up or be held at a valid VIH in order to minimize the power-up current.
3. Refer to the HY5117404A data sheet for detailed information.
4. Measured with a load equivalent to 2 TTL loads and 100pF.(VOH= 2.0V,VOL= 0.8V)
5. tCEZ(max.), tOEZ(MAX), tREZ(MAX) and tWEZ(MAX) define the time at which the output achieves the open circuit condition and is not referenced to output voltage levels.
6. Either tRCH or tRRH must be satisfied for a read cycle.
7. These parameters are referenced to CAS leading edge in early write cycles and to WE leading edge in late write or read-modify-write cycles.
8. tWCS is not a restrictive operating parameter. It is included in the data sheet as electrical characteristics only. If tWCS \geq tWCS(min.), the cycle is an early write cycle and data out pin will remain open circuit (high impedance) through the entire cycle.
9. Operation within the tRCD(max.) limit insures that tRAC(max.) can be met. tRCD(max.) is specified as a reference point only. If tRCD is greater than the specified tRCD(max.) limit, then access time is controlled by tCAC.
10. Operation within the tRAD(max.) limit insures that tRAC(max.) can be met. tRAD(max.) is specified as a reference point only. If tRAD is greater than the specified tRAD(max.) limit, then access time is controlled by tAA.
11. Measured with the specified current load and 100pF.
12. A burst of 2048 CAS-before-RAS refresh cycles must be executed within 32ms after exiting self refresh (for SL-part).
13. If tCWD \geq tWCS(MIN.), tRWD \geq tRWD(MIN.), tAWD \geq tAWD(MIN.) and tCPWD \geq tCPWD(MIN.), the cycle is a read modify write cycle and the data output will contain data read from the selected cell. If neither of the above conditions are met, the condition of the data out (at access time and until CAS goes back to VIH) is indeterminated.
14. In CAS before RAS self refresh mode.
In case of using distributed CAS before RAS refresh, refresh 2048 times during a 256ms after reset
In case of using burst CAS before RAS refresh, refresh 2048 times during a 32ms after reset
In case of use RAS only refresh, refresh against all refresh address during a 32ms after reset
15. If RAS goes to high before CAS high going, the open circuit condition of the output is achieved by CAS high going. If CAS goes to high before RAS high going, the open circuit condition of the output is achieved by RAS high going.

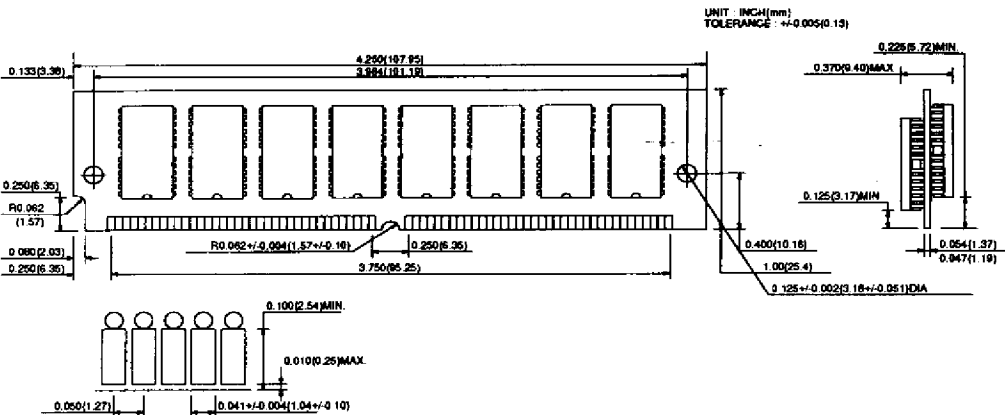
CAPACITANCE

(TA= 25°C, VCC= 5V \pm 10%, VSS= 0V, f= 1MHz, unless otherwise noted.)

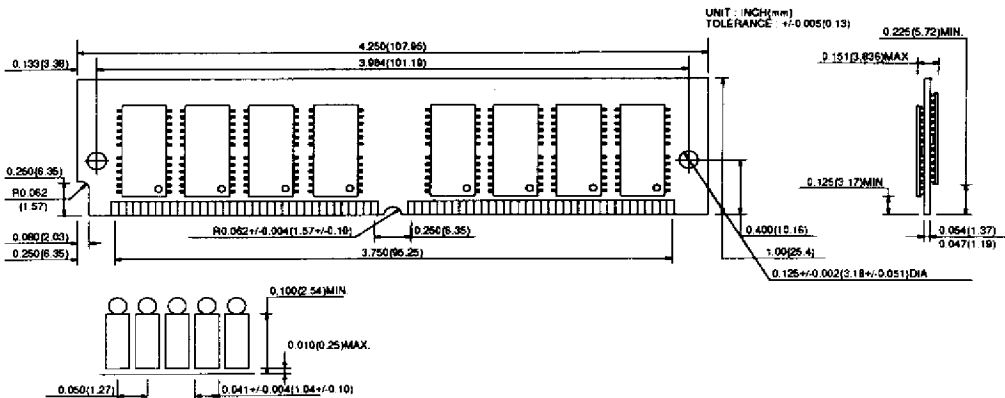
SYMBOL	PARAMETER	TYP.	MAX.	UNIT
CIN1	Input Capacitance (A0-A10)	-	110	pF
CIN2	Input Capacitance (WE)	-	120	pF
CIN3	Input Capacitance (RAS0-RAS3)	-	35	pF
CIN4	Input Capacitance (CAS0-CAS3)	-	35	pF
CDQ	Data Input/output Capacitance (DQ0-DQ31)	-	25	pF

PACKAGE INFORMATION

**72 pin Single In-line Memory (M ; Tin-Lead plated, MG ; Gold plated)
HYM532814A (SOJ Mounted)**



HYM532814A (TSOPII Mounted)



ORDERING INFORMATION

PART NUMBER	SPEED	POWER	PACKAGE	PLATING
HYM532814AM	60/70/80		SIMM	Tin-Lead
HYM532814ASLM	60/70/80	SL-part	SIMM	Tin-Lead
HYM532814ATM	60/70/80		SIMM	Tin-Lead
HYM532814ASLTM	60/70/80	SL-part	SIMM	Tin-Lead
HYM532814AMG	60/70/80		SIMM	Gold
HYM532814ASLMG	60/70/80	SL-part	SIMM	Gold
HYM532814ATMG	60/70/80		SIMM	Gold
HYM532814ASLTMG	60/70/80	SL-part	SIMM	Gold